

ABSTRACT OF THE DISCLOSURE

A method for manufacturing a ceramic electronic component includes first and second gravure-printing steps in which conductive paste and step-reducing ceramic paste are printed on a composite sheet including a ceramic green sheet. A first print mark is printed before the second gravure-printing step is performed, and the position of the first print mark is determined and compared with a desired position of the first print mark before the second gravure-printing step. Then, the second gravure-printing step is performed such that a second print mark is printed at a suitable position with respect to the position of the first print mark.